



Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
	e78
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, IrDA, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	29
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.620", 15.75mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f3221pm020sg

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Introduction

Zilog's Z8 Encore! XP MCU family of products are a line of Zilog[®] microcontroller products based upon the 8-bit eZ8 CPU. The Z8 Encore! XP[®] 64K Series Flash Microcontrollers, hereafter referred to collectively as the Z8 Encore! XP or the 64K Series adds Flash memory to Zilog's extensive line of 8-bit microcontrollers. The Flash in-circuit programming capability allows for faster development time and program changes in the field. The new eZ8TM CPU is upward compatible with existing Z8[®] instructions. The rich-peripheral set of the Z8 Encore! XP makes it suitable for a variety of applications including motor control, security systems, home appliances, personal electronic devices, and sensors.

Features

The features of Z8 Encore! XP 64K Series Flash Microcontrollers include:

- 20 MHz eZ8 CPU
- Up to 64 KB Flash with in-circuit programming capability
- Up to 4 KB register RAM
- 12-channel, 10-bit Analog-to-Digital Converter (ADC)
- Two full-duplex 9-bit UARTs with bus transceiver Driver Enable control
- Inter-integrated circuit (I²C)
- Serial Peripheral Interface (SPI)
- Two Infrared Data Association (IrDA)-compliant infrared encoder/decoders
- Up to four 16-bit timers with capture, compare, and PWM capability
- Watchdog Timer (WDT) with internal RC oscillator
- Three-channel DMA
- Up to 60 input/output (I/O) pins
- 24 interrupts with configurable priority
- On-Chip Debugger
- Voltage Brownout (VBO) Protection
- Power-On Reset (POR)
- Operating voltage of 3.0 V to 3.6 V with 5 V-tolerant inputs
- 0 °C to +70 °C, -40 °C to +105 °C, and -40 °C to +125 °C operating temperature ranges

Signal		
Mnemon	ic I/O	Description
XIN	Ι	External Crystal Input. This is the input pin to the crystal oscillator. A crystal can be connected between it and the XOUT pin to form the oscillator. This signal is usable with external RC networks and an external clock driver.
XOUT	0	External Crystal Output. This pin is the output of the crystal oscillator. A crystal can be connected between it and the XIN pin to form the oscillator. When the system clock is referred to in this manual, it refers to the frequency of the signal at this pin. This pin must be left unconnected when not using a crystal.
RCOUT	0	RC Oscillator Output. This signal is the output of the RC oscillator. It is multiplexed with a general-purpose I/O pin. This signal must be left unconnected when not using a crystal.
On-Chip	Debugger	
DBG	I/O	Debug. This pin is the control and data input and output to and from the On- Chip Debugger. This pin is open-drain.
	Caution:	For operation of the On-Chip Debugger, all power pins (V _{DD} and AV _{DD}) must be supplied with power and all ground pins (V _{SS} and AV _{SS}) must be properly grounded.
		The DBG pin is open-drain and must have an external pull-up resistor to ensure proper operation.
Reset		
RESET	Ι	RESET. Generates a Reset when asserted (driven Low).
Power Su	upply	
VDD	Ι	Power Supply.
AVDD	Ι	Analog Power Supply.
VSS	Ι	Ground.
AVSS	Ι	Analog Ground.

Table 3. Signal Descriptions (Continued)

Pin Characteristics

Table 4 on page 17 provides detailed information on the characteristics for each pin available on the 64K Series products and the data is sorted alphabetically by the pin symbol mnemonic.

16



Control Register Summary

Timer 0 High Byte T0H (F00H - Read/Write) D7 D6 D5 D4 D3 D2 D1 D0 Timer 0 current count value [15:8] **Timer 0 Low Byte** T0L (F01H - Read/Write) D7 D6 D5 D4 D3 D2 D1 D0 Timer 0 current count value [7:0] Timer 0 Reload High Byte T0RH (F02H - Read/Write) D7 D6 D5 D4 D3 D2 D1 D0 Timer 0 reload value [15:8] **Timer 0 Reload Low Byte** TORL (HF03 - Read/Write) D7 D6 D5 D4 D3 D2 D1 D0 Timer 0 reload value [7:0] **Timer 0 PWM High Byte** T0PWMH (F04H - Read/Write) D7 D6 D5 D4 D3 D2 D1 D0 — Timer 0 PWM value [15:8] Timer 0 Control 0 T0CTL0 (F06H - Read/Write) D7 D6 D5 D4 D3 D2 D1 D0 Reserved Cascade Timer 0 = Timer 0 Input signal is GPIO pin 1 = Timer 0 Input signal is Timer 3 out Reserved



D7|D6|D5|D4|D3|D2|D1|D0| Timer 1 reload value [7:0]

PS019919-1207





Data Register

PS019919-1207





42





D7 D6 D5 D4 D3 D2 D1 D0

Flash Frequency value [7:0]





Figure 12. Timer Block Diagram

Operation

The timers are 16-bit up-counters. Minimum time-out delay is set by loading the value 0001H into the Timer Reload High and Low Byte registers and setting the prescale value to 1. Maximum time-out delay is set by loading the value 0000H into the Timer Reload High and Low Byte registers and setting the prescale value to 128. If the Timer reaches FFFFH, the timer rolls over to 0000H and continues counting.

Timer Operating Modes

The timers can be configured to operate in the following modes:

ONE-SHOT Mode

In ONE-SHOT mode, the timer counts up to the 16-bit Reload value stored in the Timer Reload High and Low Byte registers. The timer input is the system clock. Upon reaching the Reload value, the timer generates an interrupt and the count value in the Timer High and Low Byte registers is reset to 0001H. Then, the timer is automatically disabled and stops counting.

Also, if the Timer Output alternate function is enabled, the Timer Output pin changes state for one system clock cycle (from Low to High or from High to Low) upon timer Reload. If it is desired to have the Timer Output make a permanent state change upon



Table 39. Timer 0-3 High Byte Register (TxH)

BITS	7	6	5	4	3	2	1	0			
FIELD	ТН										
RESET	0										
R/W		R/W									
ADDR		F00H, F08H, F10H, F18H									

Table 40. Timer 0-3 Low Byte Register (TxL)

BITS	7	6	5	4	3	2	1	0			
FIELD	TL										
RESET	0										
R/W	R/W										
ADDR	F01H, F09H, F11H, F19H										

TH and TL-Timer High and Low Bytes

These 2 bytes, {TMRH[7:0], TMRL[7:0]}, contain the current 16-bit timer count value.

Timer Reload High and Low Byte Registers

The Timer 0-3 Reload High and Low Byte (TxRH and TxRL) registers (see Table 41and Table 42 on page 92) store a 16-bit reload value, {TRH[7:0], TRL[7:0]}. Values written to the Timer Reload High Byte register are stored in a temporary holding register. When a write to the Timer Reload Low Byte register occurs, the temporary holding register value is written to the Timer High Byte register. This operation allows simultaneous updates of the 16-bit Timer Reload value.

In COMPARE mode, the Timer Reload High and Low Byte registers store the 16-bit Compare value.

BITS	7	6	5	4	3	2	1	0			
FIELD	TRH										
RESET	1										
R/W	R/W										
ADDR	F02H, F0AH, F12H, F1AH										

Table 44	T:	Delead		Durte	Deviater	(T. DII)
Table 41.	Timer 0-3	Reload	High E	Byte	Register	(1XKH)





Figure 23. SPI Configured as a Master in a Single Master, Multiple Slave System



Figure 24. SPI Configured as a Slave

Operation

The SPI is a full-duplex, synchronous, character-oriented channel that supports a four-wire interface (serial clock, transmit, receive and Slave select). The SPI block consists of a transmit/receive shift register, a Baud Rate (clock) Generator and a control unit.



Table 70. I²C Data Register (I2CDATA)

BITS	7	6	5	4	3	2	1	0				
FIELD		DATA										
RESET	0											
R/W		R/W										
ADDR				F5	0H							

I²C Status Register

The Read-only I²C Status register (Table 71) indicates the status of the I²C Controller.

Table 71	. I ² C	Status	Register	(I2CSTAT))
----------	--------------------	--------	----------	-----------	---

BITS	7	6	5	4	3	2	1	0			
FIELD	TDRE	RDRF	ACK	10B	RD	TAS	DSS	NCKI			
RESET	1	1 0									
R/W		R									
ADDR				F5	1H						

TDRE—Transmit Data Register Empty

When the I²C Controller is enabled, this bit is 1 when the I²C Data register is empty. When this bit is set, an interrupt is generated if the TXI bit is set, except when the I²C Controller is shifting in data during the reception of a byte or when shifting an address and the RD bit is set. This bit is cleared by writing to the I2CDATA register.

RDRF—Receive Data Register Full

This bit is set = 1 when the I²C Controller is enabled and the I²C Controller has received a byte of data. When asserted, this bit causes the I²C Controller to generate an interrupt. This bit is cleared by reading the I²C Data register (unless the read is performed using execution of the On-Chip Debugger's Read Register command).

ACK—Acknowledge

This bit indicates the status of the Acknowledge for the last byte transmitted or received. When set, this bit indicates that an Acknowledge occurred for the last byte transmitted or received. This bit is cleared when IEN = 0 or when a Not Acknowledge occurred for the last byte transmitted or received. It is not reset at the beginning of each transaction and is not reset when this register is read.



0101 = ADC Analog Inputs 0-5 updated. 0110 = ADC Analog Inputs 0-6 updated. 0111 = ADC Analog Inputs 0-7 updated. 1000 = ADC Analog Inputs 0-8 updated. 1001 = ADC Analog Inputs 0-9 updated. 1010 = ADC Analog Inputs 0-10 updated. 1011 = ADC Analog Inputs 0-11 updated. 1100-1111 = Reserved.

DMA Status Register

The DMA Status register (Table 85 on page 173) indicates the DMA channel that generated the interrupt and the ADC Analog Input that is currently undergoing conversion. Reads from this register reset the Interrupt Request Indicator bits (IRQA, IRQ1, and IRQ0) to 0. Therefore, software interrupt service routines that read this register must process all three interrupt sources from the DMA.

BITS	7	6	5	4	3	2	1	0			
FIELD		CAD	C[3:0]		Reserved	IRQA	IRQ1	IRQ0			
RESET		0									
R/W		R									
ADDR				FB	FH						

Table 85. DMA_ADC Status Register (DMAA_STAT)

CADC[3:0]—Current ADC Analog Input

This field identifies the Analog Input that the ADC is currently converting.

Reserved

This bit is reserved and must be 0.

IRQA—DMA_ADC Interrupt Request Indicator

This bit is automatically reset to 0 each time a read from this register occurs.

 $0 = DMA_ADC$ is not the source of the interrupt from the DMA Controller.

1 = DMA_ADC completed transfer of data from the last ADC Analog Input and generated an interrupt.

IRQ1—DMA1 Interrupt Request Indicator

This bit is automatically reset to 0 each time a read from this register occurs.

0 = DMA1 is not the source of the interrupt from the DMA Controller.

1 = DMA1 completed transfer of data to/from the End Address and generated an interrupt.

IRQ0—DMA0 Interrupt Request Indicator

This bit is automatically reset to 0 each time a read from this register occurs.

- 3. Write the first unlock command 73H to the Flash Control register.
- 4. Write the second unlock command 8CH to the Flash Control register.
- 5. Re-write the page written in step 2 to the Page Select register.

Flash Sector Protection

The Flash Sector Protect register can be configured to prevent sectors from being programmed or erased. Once a sector is protected, it cannot be unprotected by user code. The Flash Sector Protect register is cleared after reset and any previously written protection values is lost. User code must write this register in their initialization routine if they want to enable sector protection.

The Flash Sector Protect register shares its Register File address with the Page Select register. The Flash Sector Protect register is accessed by writing the Flash Control register with 5EH. Once the Flash Sector Protect register is selected, it can be accessed at the Page Select Register address. When user code writes the Flash Sector Protect register, bits can only be set to 1. Thus, sectors can be protected, but not unprotected, via register write operations. Writing a value other than 5EH to the Flash Control register de-selects the Flash Sector Protect register and re-enables access to the Page Select register.

Follow the steps below to setup the Flash Sector Protect register from user code:

- 1. Write 00H to the Flash Control register to reset the Flash Controller.
- 2. Write 5EH to the Flash Control register to select the Flash Sector Protect register.
- 3. Read and/or write the Flash Sector Protect register which is now at Register File address FF9H.
- 4. Write 00H to the Flash Control register to return the Flash Controller to its reset state.

Flash Write Protection Option Bit

The Flash Write Protect option bit can be enabled to block all program and erase operations from user code. For more information, see Option Bits on page 195.

Byte Programming

When the Flash Controller is unlocked, writes to Flash Memory from user code will program a byte into the Flash if the address is located in the unlocked page. An erased Flash byte contains all ones (FFH). The programming operation can only be used to change bits from one to zero. To change a Flash bit (or multiple bits) from zero to one requires a Page Erase or Mass Erase operation.

Byte Programming can be accomplished using the eZ8 CPU's LDC or LDCI instructions. For a description of the LDC and LDCI instructions, refer to $eZ8^{TM}$ CPU Core User Manual (UM0128).



Table 96. Flash Frequency High Byte Register (FFREQH)

BITS	7	6	5	4	3	2	1	0				
FIELD		FFREQH										
RESET	0											
R/W		R/W										
ADDR				FF	AH							

Table 97. Flash Frequency Low Byte Register (FFREQL)

BITS	7	6	5	4	3	2	1	0			
FIELD	FFREQL										
RESET	0										
R/W		R/W									
ADDR				FF	BH						

FFREQH and FFREQL—Flash Frequency High and Low Bytes

These 2 bytes, {FFREQH[7:0], FFREQL[7:0]}, contain the 16-bit Flash Frequency value.



Operation

OCD Interface

The On-Chip Debugger uses the DBG pin for communication with an external host. This one-pin interface is a bi-directional open-drain interface that transmits and receives data. Data transmission is half-duplex, in that transmit and receive cannot occur simultaneously. The serial data on the DBG pin is sent using the standard asynchronous data format defined in RS-232. This pin can interface the 64K Series products to the serial port of a host PC using minimal external hardware. Two different methods for connecting the DBG pin to an RS-232 interface are depicted in Figure 37 and Figure 38 on page 201.



Caution: For operation of the On-Chip Debugger, all power pins $(V_{DD} \text{ and } AV_{DD})$ must be supplied with power, and all ground pins $(V_{SS} \text{ and } AV_{SS})$ must be properly grounded.

The DBG pin is open-drain and must always be connected to V_{DD} through an external pull-up resistor to ensure proper operation.



Figure 37. Interfacing the On-Chip Debugger's DBG Pin with an RS-232 Interface (1)

Figure 45 displays the typical current consumption in HALT mode while operating at 25 °C versus the system clock frequency. All GPIO pins are configured as outputs and driven High.



Figure 45. Typical HALT Mode Idd Versus System Clock Frequency

zilog

225

Figure 48 displays the maximum current consumption in STOP mode with the VBO disabled and Watchdog Timer enabled versus the power supply voltage. All GPIO pins are configured as outputs and driven High. Disabling the Watchdog Timer and its internal RC oscillator in STOP mode will provide some additional reduction in STOP mode current consumption. This small current reduction would be indistinguishable on the scale of Figure 48.



Figure 48. Maximum STOP Mode Idd with VBO Disabled versus Power Supply Voltage





Assembly Mnemonic	Symbolic Operation	Address Mode		Oneeda(a)	Flags						Fatab	Inotr
		dst	src	(Hex)	С	Ζ	S	V	D	Н	Cycles	Cycles
AND dst, src	dst ← dst AND src - - -	r	r	52	- -	*	*	0	-	-	2	3
		r	lr	53							2	4
		R	R	54							3	3
		R	IR	55							3	4
		R	IM	56							3	3
		IR	IM	57							3	4
ANDX dst, src	$dst \gets dst \ AND \ src$	ER	ER	58	-	*	*	0	-	-	4	3
	-	ER	IM	59							4	3
ATM	Block all interrupt and DMA requests during execution of the next 3 instructions			2F	-	-	-	-	-	-	1	2
BCLR bit, dst	dst[bit] ← 0	r		E2	-	*	*	0	-	-	2	2
BIT p, bit, dst	dst[bit] ← p	r		E2	-	*	*	0	-	-	2	2
BRK	Debugger Break			00	-	-	-	-	-	-	1	1
BSET bit, dst	dst[bit] ← 1	r		E2	-	*	*	0	-	-	2	2
BSWAP dst	dst[7:0] ← dst[0:7]	R		D5	Х	*	*	0	-	-	2	2
BTJ p, bit, src, dst	if src[bit] = p PC \leftarrow PC + X		r	F6	-	-	-	-	-	-	3	3
			lr	F7							3	4
BTJNZ bit, src, dst	if src[bit] = 1 PC \leftarrow PC + X		r	F6	-	-	-	-	-	-	3	3
			lr	F7							3	4
BTJZ bit, src, dst	if src[bit] = 0 PC \leftarrow PC + X		r	F6	-	-	-	-	-	-	3	3
			lr	F7							3	4
CALL dst	$\begin{array}{l} SP \leftarrow SP \text{ -2} \\ \texttt{@SP} \leftarrow PC \\ PC \leftarrow dst \end{array}$	IRR		D4	-	-	-	-	-	-	2	6
		DA		D6							3	3
CCF	C ← ~C			EF	*	-	-	-	-	-	1	2
CLR dst	dst ← 00H	R		B0	-	-	-	-	-	-	2	2
		IR		B1							2	3

Table 133. eZ8 CPU Instruction Summary (Continued)

zilog



Figure 66. 68-Lead Plastic Lead Chip Carrier Package (PLCC)

Figure 66 displays the 68-pin Plastic Lead Chip Carrier (PLCC) package available for the Z8X1622, Z8X2422, Z8X3222, Z8X4822, and Z8X6422 devices.

268



286

architecture 103 asynchronous data format without/with parity 105 baud rate generator 113 baud rates table 122 control register definitions 114 controller signals 15 data format 104 interrupts 111 multiprocessor mode 109 receiving data using interrupt-driven method 108 receiving data using the polled method 107 transmitting data using the interrupt-driven method 106 transmitting data using the polled method 105 x baud rate high and low registers 120 x control 0 and control 1 registers 117 x status 0 and status 1 registers 115, 116 UxBRH register 121 UxBRL register 121 UxCTL0 register 117, 120 UxCTL1 register 118 UxRXD register 115 UxSTAT0 register 115 UxSTAT1 register 117 UxTXD register 114

V

vector 243 voltage brown-out reset (VBR) 50

W

watch-dog timer approximate time-out delay 98 approximate time-out delays 97 CNTL 50 control register 100 electrical characteristics and timing 228 interrupt in normal operation 98 interrupt in STOP mode 98 operation 97 refresh 98, 248 reload unlock sequence 99 reload upper, high and low registers 101 reset 51 reset in normal operation 99 reset in STOP mode 99 time-out response 98 WDTCTL register 100 WDTH register 102 WDTL register 102 working register 243 working register pair 243 WTDU register 102

Χ

X 243 XOR 249 XORX 249

Ζ

Z8 Encore! block diagram 3 features 1 introduction 1 part selection guide 2